

S2C-SMT 3.50/22/90LF 1.5SN BK BX**Weidmüller Interface GmbH & Co. KG**

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com

Product image

Similar to illustration

High-temperature-resistant male header

- Finger-safe
- Can be plugged into female plug B2CF 3.50 PUSH IN
- **Plug-in direction is perpendicular or parallel to the circuit board (180° / 90°)**
- Housing variants: closed (G) and with solder flange (LF)
- **Packed either in a box (BX) or on anti-static tape-on-reel (RL)**
- Suitable for reflow and wave soldering applications
- Pin length of either 1.5 mm or 3.2 mm

General ordering data

| | |
|--------------|--|
| Version | PCB plug-in connector, male header, Solder flange, THT/THR solder connection, 3.50 mm, Number of poles: 22, 90°, Solder pin length (l): 1.5 mm, tinned, black, Box |
| Order No. | 1289950000 |
| Type | S2C-SMT 3.50/22/90LF 1.5SN BK BX |
| GTIN (EAN) | 4050118083781 |
| Qty. | 36 pc(s). |
| Product data | IEC: 200 V / 13.4 A UL: 150 V / 10 A |
| Packaging | Box |

Creation date September 16, 2022 3:11:23 AM CEST

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Technical data**Dimensions and weights**

| | | | |
|--------------------------|------------|-----------------|------------|
| Depth | 14.2 mm | Depth (inches) | 0.559 inch |
| Height | 12.3 mm | Height (inches) | 0.484 inch |
| Height of lowest version | 10.8 mm | Width | 45.5 mm |
| Width (inches) | 1.791 inch | Net weight | 9.333 g |

System specifications

| | | | |
|--|--|--|-----------------------|
| Product family | OMNIMATE Signal - series B2C/S2C 3.50 - 2-row | Type of connection | Board connection |
| Mounting onto the PCB | THT/THR solder connection | Pitch in mm (P) | 3.5 mm |
| Pitch in inches (P) | 0.138 inch | Outgoing elbow | 90° |
| Number of poles | 22 | Number of solder pins per pole | 1 |
| Solder pin length (l) | 1.5 mm | Solder pin dimensions | d = 1.0 mm, Octagonal |
| Solder eyelet hole diameter (D) | 1.3 mm | Solder eyelet hole diameter tolerance (D) + 0,1 mm | |
| Outside diameter of solder pad | 2.1 mm | Template aperture diameter | 1.9 mm |
| L1 in mm | 35 mm | L1 in inches | 1.378 inch |
| Number of rows | 1 | Pin series quantity | 2 |
| Touch-safe protection acc. to DIN VDE 57 106 | touch-safe on connector face, safe to back of hand above the printed circuit board | Touch-safe protection acc. to DIN VDE 0470 | |
| Can be coded | Yes | | IP 20 |
| Pulling force/pole, max. | 2.5 N | Plugging force/pole, max. | 3.5 N |

Material data

| | | | |
|---------------------------------------|---------------------------|---------------------------------------|--------------------------------|
| Insulating material | LCP GF | Colour | black |
| Colour chart (similar) | RAL 9011 | Insulating material group | IIIb |
| Comparative Tracking Index (CTI) | ≥ 175 | Moisture Level (MSL) | 1 |
| UL 94 flammability rating | V-0 | Contact material | Copper alloy |
| Contact surface | tinned | Layer structure of solder connection | 1...3 µm Ni / 2...5 µm Sn matt |
| Layer structure of plug contact | 2...5 µm Sn / 1...3 µm Ni | Storage temperature, min. | -40 °C |
| Storage temperature, max. | 70 °C | Operating temperature, min. | -50 °C |
| Operating temperature, max. | 120 °C | Temperature range, installation, min. | -40 °C |
| Temperature range, installation, max. | 120 °C | | |

Rated data acc. to IEC

| | | | |
|---|------------------------|---|------------------|
| tested acc. to standard | IEC 60664-1, IEC 61984 | Rated current, min. number of poles (Tu=20°C) | 13.4 A |
| Rated current, min. number of poles (Tu=40°C) | 12 A | Rated voltage for surge voltage class / pollution degree II/2 | 200 V |
| Rated voltage for surge voltage class / pollution degree III/2 | 160 V | Rated voltage for surge voltage class / pollution degree III/3 | 80 V |
| Rated impulse voltage for surge voltage class/ pollution degree II/2 | 2.5 kV | Rated impulse voltage for surge voltage class/ pollution degree III/2 | 2.5 kV |
| Rated impulse voltage for surge voltage class/ contamination degree III/3 | 2.5 kV | Short-time withstand current resistance | 3 x 1s with 80 A |

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Technical data**Rated data acc. to CSA**

Institute (CSA)



Certificate No. (CSA)

200039-1121690

Rated voltage (Use group B / CSA) 150 V

Rated voltage (Use group C / CSA) 50 V

Rated voltage (Use group D / CSA) 150 V

Rated current (Use group B / CSA) 9.5 A

Rated current (Use group C / CSA) 9.5 A

Rated current (Use group D / CSA) 9.5 A

Reference to approval values

Specifications are maximum values, details - see approval certificate.

Packing

Packaging Box

VPE length 338 mm

VPE width 130 mm

VPE height 20 mm

Classifications

ETIM 6.0 EC002637

ETIM 7.0 EC002637

ETIM 8.0 EC002637

ECLASS 9.0 27-44-04-02

ECLASS 9.1 27-44-04-02

ECLASS 10.0 27-44-04-02

ECLASS 11.0 27-46-02-01

ECLASS 12.0 27-46-02-01

Important note

IPC conformity

Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.

Notes

- Gold-plated contact surfaces on request
- Rated current related to rated cross-section & min. No. of poles.
- Spacing between rows: see hole layout
- P on drawing = pitch
- Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.
- Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months

Approvals

Approvals



ROHS Conform

UL File Number Search UL Website

Certificate No. (cURus) E60693

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Technical data

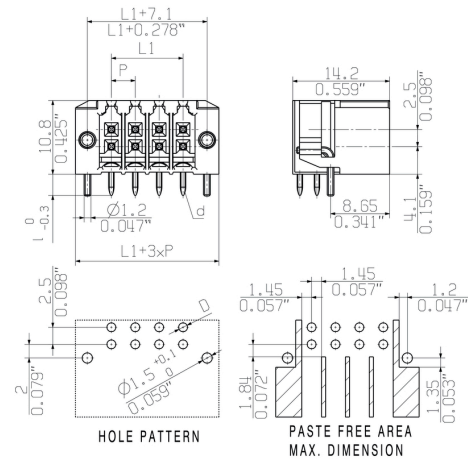
Downloads

| | |
|---|---|
| Approval/Certificate/Document of Conformity | Declaration of the Manufacturer |
| Engineering Data | CAD data – STEP |
| Engineering Data | EPLAN, WSCAD |
| Catalogues | Catalogues in PDF-format |
| Brochures | FL DRIVES EN |
| | MB SMT EN |
| | FL DRIVES DE |
| | MB DEVICE MANUF. EN |
| | FL BUILDING SAFETY EN |
| | FL APPL LED LIGHTING EN |
| | FL INDUSTR.CONTROLS EN |
| | FL MACHINE SAFETY EN |
| | FL HEATING ELECTR EN |
| | FL APPL INVERTER EN |
| | FL_BASE_STATION_EN |
| | FL ELEVATOR EN |
| | FL POWER SUPPLY EN |
| | FL 72H SAMPLE SER EN |
| White paper surface mount technology | Download Whitepaper |

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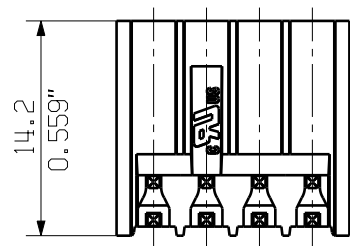
Drawings**Dimensional drawing**

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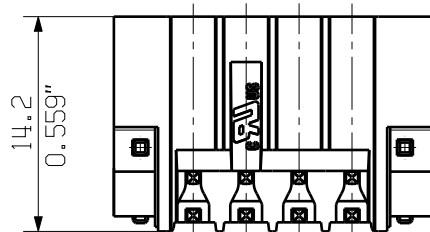
© Weidmüller Interface GmbH & Co. KG

Dimensions without tolerances are no check dimensions

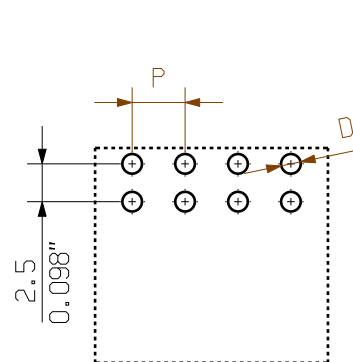
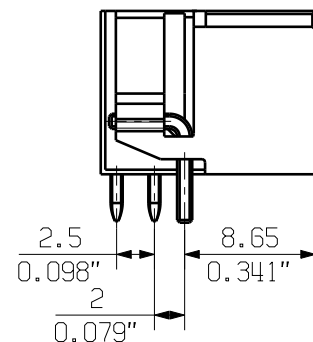
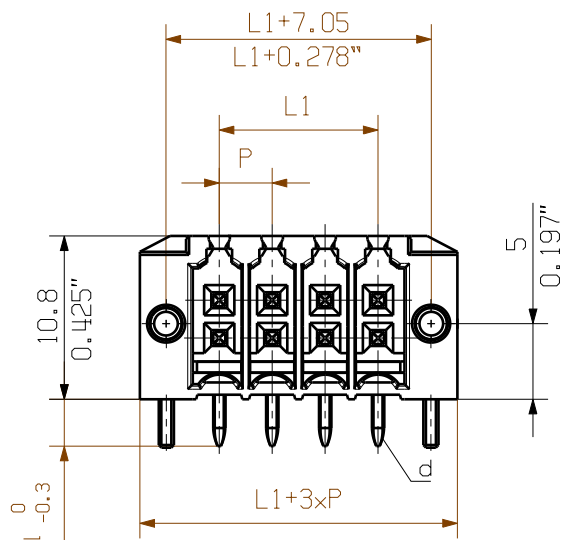
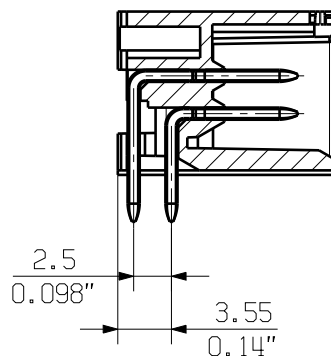
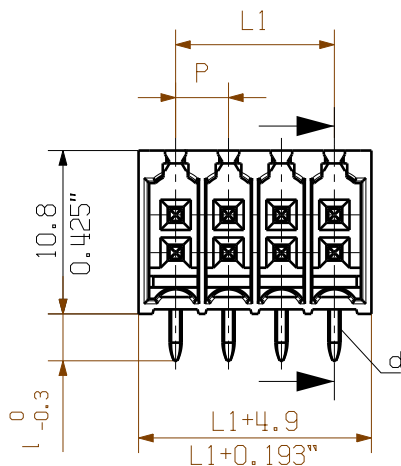
The English version is binding



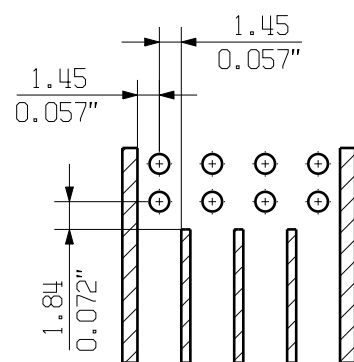
SHOWN: S2C-SMT 3.50/08/90G 3.2



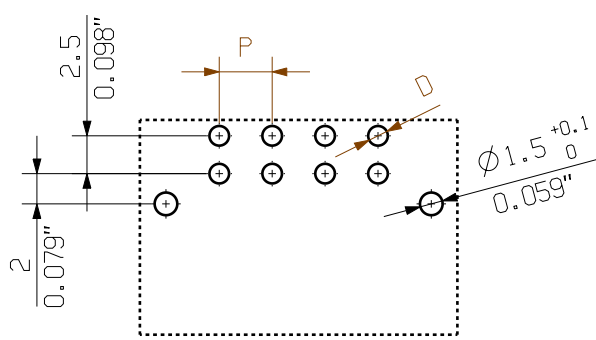
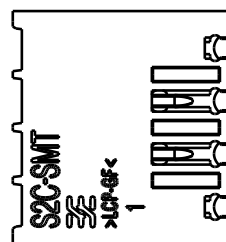
SHOWN: S2C-SMT 3.50/08/90LF 3.2



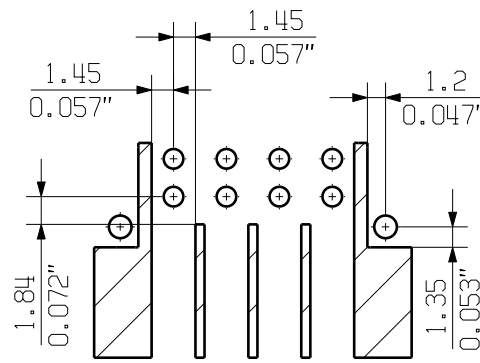
HOLE PATTERN



PASTE FREE AREA
MAX. DIMENSION



HOLE PATTERN



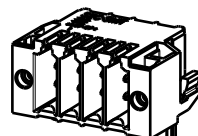
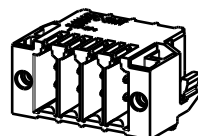
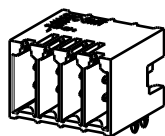
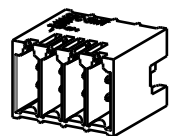
PASTE FREE AREA
MAX. DIMENSION

M 1/1
S2C-SMT 3.50/08/90G 1.5

M 1/1
S2C-SMT 3.50/08/90G 3.2

M 1/1
S2C-SMT 3.50/08/90LF 1.5

M 1/1
S2C-SMT 3.50/08/90LF 3.2



P = 3.50 RASTER
PITCH

D* = Ø1.3 +0.1/-0.051"

d = 0.8x0.8
0.031"x0.031"

* from n (no of poles) 26
D = 1.4mm +0.1

| | | |
|--------------------------|------|--------|
| S2C-SMT 3.50...180LF 3.5 | 3.5 | 0.126 |
| S2C-SMT 3.50...180LF 1.5 | 1.5 | 0.059 |
| S2C-SMT 3.50...180G 3.5 | 3.2 | 0.126 |
| S2C-SMT 3.50...180G 1.5 | 1.5 | 0.059 |
| TYP | | |
| PART NAME | [mm] | [inch] |

For the mounting of PCBs, it should be noted that the rated data relates only to the PCB components alone.
The necessary creepage and clearance paths must be observed in connection with the respective applicant in accordance to IEC 664 / VDE 0110.
The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine.

Weidmüller PCB components are tested to the DIN EN 61984 standard, and are valid for its field of application. Provided that the components are used to the intended purpose, all requirements with respect to the occurring of electrical, mechanical, thermic and corrosive stress will be satisfied.

| | | | |
|--------------------|------------|--------------|-----------------------|
| 36 | 59.5 | 2.343 | ±0.2 |
| 34 | 56.0 | 2.205 | |
| 32 | 52.5 | 2.067 | |
| 30 | 49.0 | 1.929 | |
| 28 | 45.5 | 1.791 | ±0.15 |
| 26 | 42.0 | 1.654 | |
| 24 | 38.5 | 1.516 | |
| 22 | 35.0 | 1.378 | |
| 20 | 31.5 | 1.240 | ±0.1 |
| 18 | 28.0 | 1.102 | |
| 16 | 24.5 | 0.965 | |
| 16 | 24.5 | 0.965 | |
| 14 | 21.0 | 0.827 | |
| 12 | 17.5 | 0.689 | |
| 10 | 14.0 | 0.551 | |
| 8 | 10.5 | 0.413 | |
| 6 | 7.00 | 0.276 | |
| 4 | 3.50 | 0.138 | |
| n POLZAHL POLES | L1 [mm] | L1 [inch] | TOLERANZ TOLERANCE |

allgemeinguetliche Kundenzeichnung, aktueller Stand nur auf Anfrage
general customer drawing, topical version only if required

GENERAL TOLERANCE:
DIN ISO 2768-m

Max. nos.

99681/4
22.03.18 AMANN_A 01
Modification

Weidmüller

Cat.no.: .

3 50160 **06**

Drawing no. Issue no.
Sheet 02 of 04 sheets

| | | | |
|--|-------------|------------|------------|
| | Drawn | 15.07.2011 | FRIELING_L |
| | Responsible | | AMANN_A |
| | Checked | 04.04.2018 | HELIS_MA |
| | Approved | | LANG_T |

S2C-SMT 3.50/.../...
STIFTELEISTE
MALE HEADER

Product file: B2CF/S2C

7400

Recommended wave soldering profiles

Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 16
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Germany
Fon: +49 5231 14-0
Fax: +49 5231 14-292083
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Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

We reserve the right to make technical changes.

Recommended reflow soldering profile

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Fax: +49 5231 14-292083

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3\text{K/s}$. In parallel the solder paste is 'activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at $\geq -6\text{K/s}$ solder is cured. Board and components cool down while avoiding cold cracks.